

AP40T10GI-HF-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)
100	0.034 at V _{GS} = 10 V	50 ^a

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

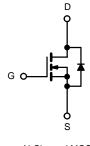
APPLICATIONS

• Isolated DC/DC Converters





GDS



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20	- V	
Continuous Drain Current (T_{1} = 175 °C)	T _C = 25 °C	1-	50 ^a		
Continuous Drain Current (1) = 175 C)	T _C = 125 °C	I _D	28 ^a	A	
Pulsed Drain Current		I _{DM}	120	A	
Avalanche Current	L = 0.1 mH	I _{AS}	31		
Single Pulse Avalanche Energy ^b	L = 0.11111	E _{AS}	61	mJ	
Mariana David Diasia di sub	T _C = 25 °C	Р	360 ^c	10/	
Maximum Power Dissipation ^b	T _A = 25 °C ^d	- P _D -	3.70	- W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE R	ATINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	C/W

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

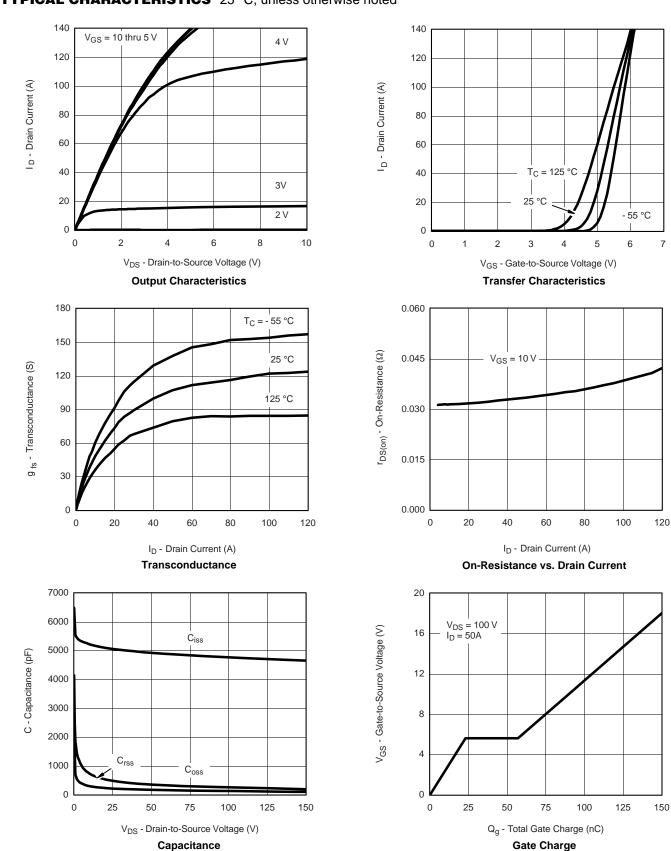
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WV	vw.V	/Bsemi.com	

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	•					
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.5		2.5	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		V _{DS} = 100 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μA
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А
		V _{GS} = 10 V, I _D = 30 A		0.034		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.063		Ω
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.084		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S
Dynamic ^b	•					
Input Capacitance	C _{iss}			5100		Α Ω
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		480		
Reverse Transfer Capacitance	C _{rss}			210		
Total Gate Charge ^c	Qg			90	130	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 65 A		23		nC
Gate-Drain Charge ^c	Q _{gd}			34		
Gate Resistance	Rg		0.5	1.7	3.3	Ω
Turn-On Delay Time ^c	t _{d(on)}			24	35	
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 1.5 Ω		220	330	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 65 A, V_GEN = 10 V, R_g = 2.5 Ω		45	70	ns
Fall Time ^c	t _f			200	300	
Source-Drain Diode Ratings and Cha	aracteristics 7	_C = 25 °C ^b		·		
Continuous Current	ا _S			50		
Pulsed Current	I _{SM}			120		A
Forward Voltage ^a	V _{SD}	$I_{F} = 65 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/µs		8	12	А
Reverse Recovery Charge	Q _{rr}			0.52	1.2	uС

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.

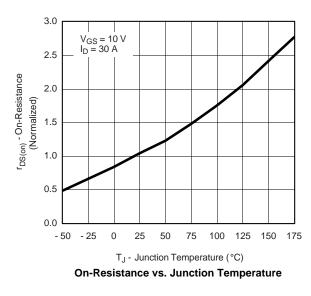


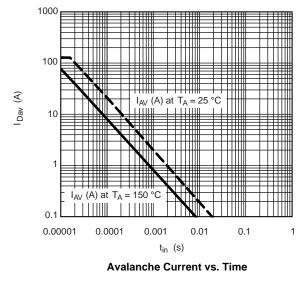


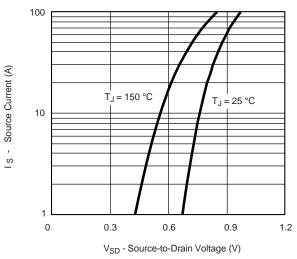
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



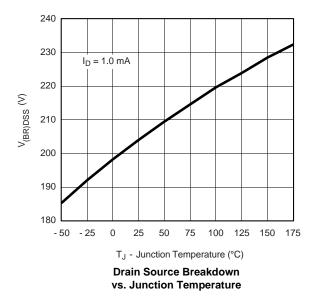
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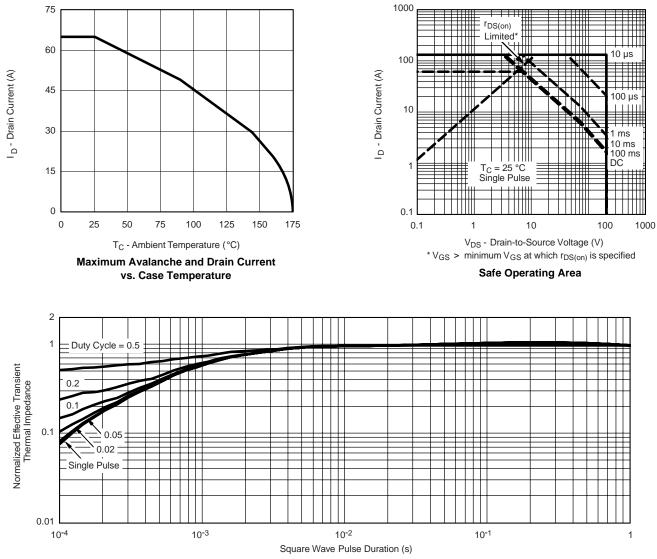
Source-Drain Diode Forward Voltage



AP40T10GI-HF-VB



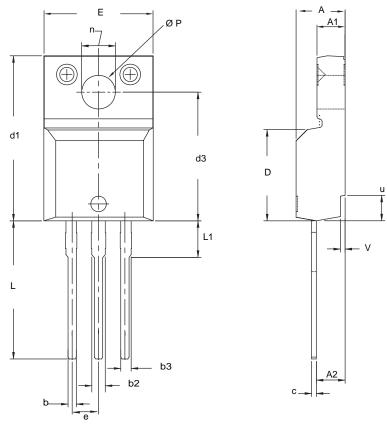
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK (HIGH VOLTAGE)



DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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